

TEM96C

Thermal Conductive RF Absorber Pad

LiPOLY TEM96C is a thermally conductive absorber based upon soft magnetic materials dispersed in a polymeric resin. It has a thermal conductivity of 4.0 W/m*K and dissipates electromagnetic radiation rapidly to mitigate against EMI issues.

FEATURES

- / Thermal conductivity: 4.0 W/m*K
- / Excellent absorption characteristics
- / Naturally tacky
- / Reworkable

TYPICAL APPLICATION

- / IC, CPU, MOS, LED, M/B, Heat sink
- / LCD-TV, Notebook PC, PC, Telecom device, Wireless hub
- / DDR II module, DVD applications, Hand-set applications
- / 5G base station & infrastructure
- / EV electric vehicle

SPECIFICATIONS

- / Sheet form
- / Die-cut parts

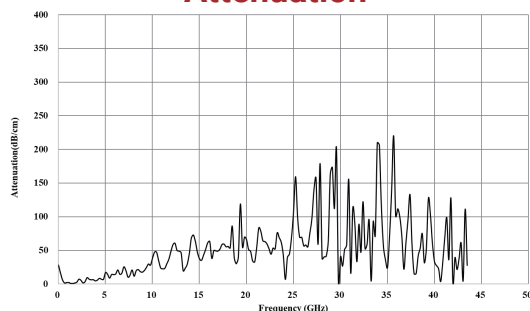
FREQUENCY APPLICATION

- 2.4 GHz Wi-Fi Router , Bluetooth
- 3.5 GHz 5G Mobile Networks
- 5.0 GHz Wi-Fi Router
- 6.0 GHz Wi-Fi Route
- 12~18 GHz Low Earth Orbit (LEO) System
- 28 GHz 5G Mobile Networks
- 39 GHz 5G Mobile Networks

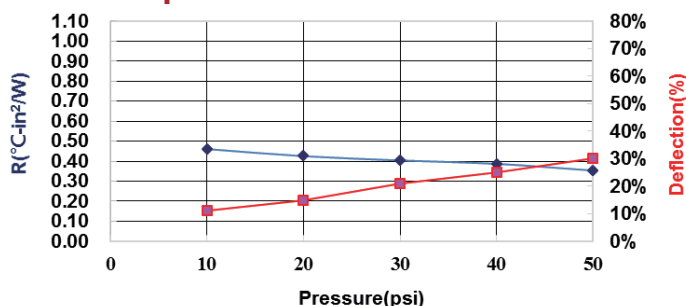
TYPICAL PROPERTIES

PROPERTY	TEM96C	TEST METHOD	UNIT
Color	Dark Gray	Visual	-
Surface tack 2-side/1-side	2	-	-
Thickness	0.5~5.0	ASTM D374	mm
Density	3.6	ASTM D792	g/cm ³
Hardness	55	ASTM D2240	Shore OO
TML	0.04	By LiPOLY	%
Water absorption	0.04	ASTM D570	%
Application temperature	-60~180	-	°C
ROHS & REACH	Compliant	-	-
COMPRESSION@1.0mm			
Deflection @10 psi	11	ASTM D5470 modify	%
Deflection @20 psi	15	ASTM D5470 modify	%
Deflection @30 psi	21	ASTM D5470 modify	%
Deflection @40 psi	25	ASTM D5470 modify	%
Deflection @50 psi	30	ASTM D5470 modify	%
EMI Attenuation @1.0mm			
EMI attenuation@ 2.4 GHz	7.0	ASTM D4935 modify	dB/cm
EMI attenuation@ 3.5 GHz	6.7	ASTM D4935 modify	dB/cm
EMI attenuation@ 5.0 GHz	15.8	ASTM D4935 modify	dB/cm
EMI attenuation@ 6.0 GHz	14.8	ASTM D4935 modify	dB/cm
EMI attenuation@ 12 GHz	43.7	ASTM D4935 modify	dB/cm
EMI attenuation@ 18 GHz	56.8	ASTM D4935 modify	dB/cm
EMI attenuation@ 28 GHz	76.6	ASTM D4935 modify	dB/cm
EMI attenuation@ 39 GHz	45.5	ASTM D4935 modify	dB/cm
ELECTRICAL			
Surface resistivity	>10 ¹¹	ASTM D257	Ohm
Volume resistivity	>10 ¹⁰	ASTM D257	Ohm-m
THERMAL			
Thermal conductivity	4.0	ASTM D5470	W/m*K
Thermal impedance@10 psi	0.462	ASTM D5470	°C-in ² / W
Thermal impedance@20 psi	0.426	ASTM D5470	°C-in ² / W
Thermal impedance@30 psi	0.404	ASTM D5470	°C-in ² / W
Thermal impedance@40 psi	0.387	ASTM D5470	°C-in ² / W
Thermal impedance@50 psi	0.353	ASTM D5470	°C-in ² / W

Attenuation



Thermal Impedance vs. Pressure vs. Deflection



Note: All specifications provided by LiPOLY are subject to change without notice. The test methods used by LiPOLY are based on the TIM Tester method and ASTM D5470 test method. These test methods are used as the definition standards for LiPOLY. Property values provided in this document are not for product specifications or guaranteed. This document does not guarantee the performance and quality required for the purchaser's specific purpose. The purchaser needs to evaluate and verify the safety before using the material. We strongly recommend the purchaser pre-test the product and verify the performance of the product under the purchaser's specific conditions. Liability and use of the product are the responsibility of the end user. LiPOLY makes no warranty as to the suitability, merchantability, or non-infringement of any LiPOLY material or product for any specific or general uses. LiPOLY shall not be liable for incidental or consequential damages of any kind. All LiPOLY products are sold in accordance with the LiPOLY Terms and Conditions in effect at the time of purchase and a copy of which will be furnished upon request. All rights reserved, including LiPOLY trademarks or registered trademarks of LiPOLY or its affiliates. Statements concerning possible or suggested uses made herein shall not be relied upon or be constructed as a guaranty of patent infringement. Copyright LiPOLY.